

# KPGB-0607VBA1ZGC

0.65 x 0.65 x 0.25 mm Bi-Color Surface Mount LED



## **DESCRIPTIONS**

- The Blue source color devices are made with InGaN on Sapphire substrate Light Emitting Diode
- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode
- · Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- · All devices, equipments and machineries must be electrically grounded

## **FEATURES**

- 0.65 mm x 0.65 mm SMD LED, 0.25 mm thickness
- · Low power consumption
- Package: 4000 pcs / reel
- · Moisture sensitivity level: 3
- Halogen-free
- RoHS compliant

## **APPLICATIONS**

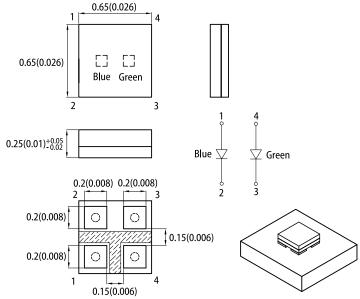
- Backlight
- · Status indicator
- · Home and smart appliances
- · Wearable and portable devices
- · Healthcare applications

### **ATTENTION**

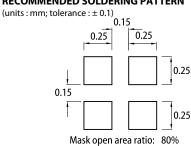
Observe precautions for handling electrostatic discharge sensitive devices



## **PACKAGE DIMENSIONS**



### RECOMMENDED SOLDERING PATTERN



### Notes:

- oles.

  All dimensions are in millimeters (inches).

  Tolerance is ±0.1(0.004") unless otherwise noted.
- All dimensions are in millimeters (inches).
   Tolerance is ±0.1(0.004") unless otherwise noted.
   The specifications, characteristics and technical data described in the datasheet are subject to

Mask thickness: 80~100um

The specifications, crief exercises and reministrate data deconstance without prior notice.

The device has a single mounting surface. The device must be mounted according to the specifications.

## **SELECTION GUIDE**

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 5mA [2]		Viewing Angle [1]
			Min.	Тур.	201/2
KPGB-0607VBA1ZGC	■ Blue (InGaN)	Water Clear	10	40	440°
	■ Green (InGaN)		50	200	140°

Notes.

1. 61/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity / luminous flux: +/-15%.

3. Luminous intensity value is traceable to CIE127-2007 standards.



# ELECTRICAL / OPTICAL CHARACTERISTICS at T<sub>A</sub>=25°C

Parameter	Symbol	Emitting Color	Value		Unit
raianietei		Emitting Color	Тур.	Max.	Ullit
Wavelength at Peak Emission I <sub>F</sub> = 5mA	$\lambda_{ m peak}$	Blue Green	463 515	-	nm
Dominant Wavelength I <sub>F</sub> = 5mA	λ <sub>dom</sub> <sup>[1]</sup>	Blue Green	468 525	-	nm
Spectral Bandwidth at 50% $\Phi$ REL MAX I <sub>F</sub> = 5mA	Δλ	Blue Green	25 30	-	nm
Forward Voltage I <sub>F</sub> = 5mA	V <sub>F</sub> <sup>[2]</sup>	Blue Green	2.9 2.85	3.2 3.3	V
Reverse Current (V <sub>R</sub> = 5V)	I <sub>R</sub>	Blue Green	-	50 50	μА
Temperature Coefficient of $\lambda_{peak}$ I <sub>F</sub> = 5mA, -10°C $\leq$ T $\leq$ 85°C	$TC_{\lambda peak}$	Blue Green	0.04 0.05	-	nm/°C
Temperature Coefficient of $\lambda_{dom}$ $I_F$ = 5mA, -10°C $\leq T \leq 85^{\circ}C$	$TC_{\lambdadom}$	Blue Green	0.03 0.03	-	nm/°C
Temperature Coefficient of $V_F$ $I_F$ = 5mA, -10°C $\leq$ T $\leq$ 85°C	TC <sub>V</sub>	Blue Green	-3.0 -3.0	-	mV/°C

# ABSOLUTE MAXIMUM RATINGS at T<sub>A</sub>=25°C

Parameter	Symbol	Va	Unit	
Parameter		Blue	Green	Unit
Power Dissipation	P <sub>D</sub> <sup>[1]</sup>	3	mW	
Reverse Voltage	V <sub>R</sub>	5	5	V
Junction Temperature	Tj	115	115	°C
Operating Temperature	T <sub>op</sub>	-40 T	°C	
Storage Temperature	T <sub>stg</sub>	-40 To +100		°C
DC Forward Current	I <sub>F</sub> <sup>[2]</sup>	10	10	mA
Peak Forward Current	I <sub>FP</sub> <sup>[3]</sup>	50	50	mA
Electrostatic Discharge Threshold (HBM)	-	250	450	V
Thermal Resistance (Junction / Ambient)	R <sub>th JA</sub> [4]	720	780	°C/W
Thermal Resistance (Junction / Solder point)	R <sub>th JS</sub> <sup>[4]</sup>	580	650	°C/W

Notes:

1. Within 35mW when multiple chips are lightened

2. The maximum ratings are valid for the case of lighting a single chip
When two chips are lit at the same time, each chip should be driven at a current lower than 50% of the absolute maximum ratings

3. Duty Cycle ≤ 1 / 20, Pulse Width = 1ms.

4. R<sub>10. JA</sub>, R<sub>10. JS</sub> Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad).

5. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

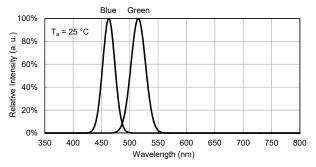


<sup>1.</sup> The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd: ±1nm.)
2. Forward voltage: ±0.1V.
3. Wavelength value is traceable to CIE127-2007 standards.
4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

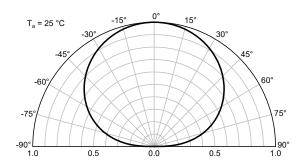


# **TECHNICAL DATA**

## **RELATIVE INTENSITY vs. WAVELENGTH**

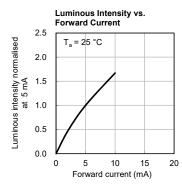


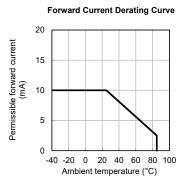
## **SPATIAL DISTRIBUTION**

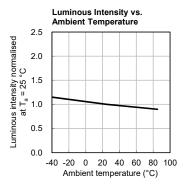


# **BLUE**

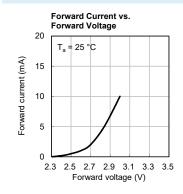
Forward Current vs. **Forward Voltage** T<sub>a</sub> = 25 °C Forward current (mA) 15 10 5 0 2.3 2.5 2.7 2.9 3.1 3.3 3.5 Forward voltage (V)

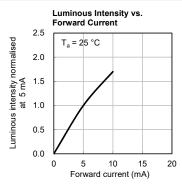


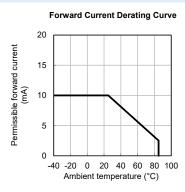


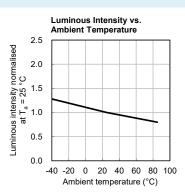


# **GREEN**









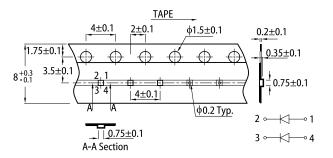


## **REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS**

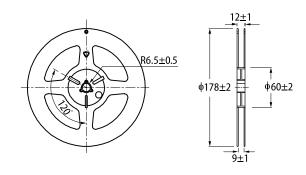
#### 300 above 255°C (°C) 260°C max. 30s max. 10s max. 250 3°C/s max 6°C/s max. 200 150 pre-heating 100 150~200°C above 217°C 60~120s 60~150s 50 0 0 50 100 150 200 250 (sec) Time

- 1. Don't cause stress to the LEDs while it is exposed to high temperature.
  2. The maximum number of reflow soldering passes is 2 times.
  3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

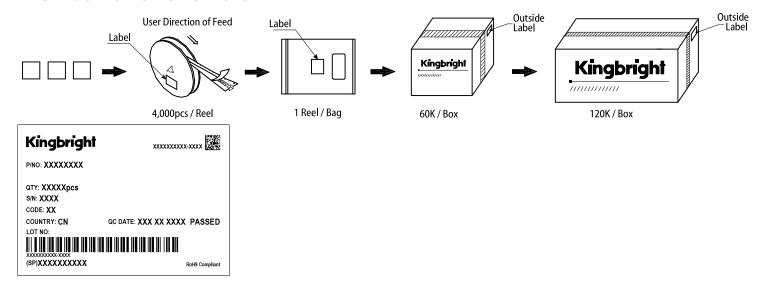
## TAPE SPECIFICATIONS (units:mm)



### **REEL DIMENSION** (units: mm)



## **PACKING & LABEL SPECIFICATIONS**



## **PRECAUTIONARY NOTES**

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.

  The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening
- liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.
- The contents and information of this document may not be reproduced or re-transmitted without permission by Kingbright. All design applications should refer to Kingbright application notes available at <a href="https://www.kingbright.com/application">https://www.kingbright.com/application</a> not

